

BLF10H6600P; BLF10H6600PS

Power LDMOS transistor

Rev. 3 — 1 September 2015

AMMPELON

Product data sheet

1. Product profile

1.1 General description

A 600 W LDMOS RF power transistor for transmitter applications and industrial applications. The excellent ruggedness of this device makes it ideal for digital and analog transmitter applications.

Table 1. Application information

| Test signal | f (MHz) | $P_{L(AV)}$ (W) | $P_{L(M)}$ (W) | G_p (dB) | η_D (%) | IMD3 (dBc) |
|--|--------------------------|--------------------|-------------------|---------------|-----------------|---------------|
| RF performance in a common source 860 MHz narrowband test circuit | | | | | | |
| 2-tone, class-AB | $f_1 = 860; f_2 = 860.1$ | 250 | - | 20.8 | 46 | -32 |
| pulsed, class-AB | 860 | - | 600 | 19.8 | 58 | - |

1.2 Features and benefits

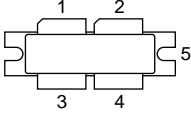
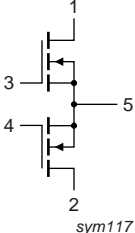
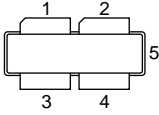
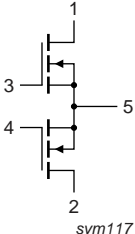
- Excellent ruggedness ($V_{SWR} \geq 40 : 1$ through all phases)
- Optimum thermal behavior and reliability, $R_{th(j-c)} = 0.15$ K/W
- High power gain
- High efficiency
- Designed for broadband operation (400 MHz to 1000 MHz)
- Internal input matching for high gain and optimum broadband operation
- Excellent reliability
- Easy power control
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- Communication transmitter applications
- Industrial applications

2. Pinning information

Table 2. Pinning

| Pin | Description | Simplified outline | Graphic symbol |
|-------------------------------|-------------|---|--|
| BLF10H6600P (SOT539A) | | | |
| 1 | drain1 |  |  sym117 |
| 2 | drain2 | | |
| 3 | gate1 | | |
| 4 | gate2 | | |
| 5 | source | | |
| BLF10H6600PS (SOT539B) | | | |
| 1 | drain1 |  |  sym117 |
| 2 | drain2 | | |
| 3 | gate1 | | |
| 4 | gate2 | | |
| 5 | source | | |

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|--------------|---------|---|---------|
| | Name | Description | Version |
| BLF10H6600P | - | flanged balanced ceramic package; 2 mounting holes; 4 leads | SOT539A |
| BLF10H6600PS | - | earless flanged balanced ceramic package; 4 leads | SOT539B |

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|----------------------|------------|------|------|------|
| V_{DS} | drain-source voltage | | - | 110 | V |
| V_{GS} | gate-source voltage | | -0.5 | +11 | V |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| T_j | junction temperature | [1] | - | 225 | °C |

[1] Continuous use at maximum temperature will affect the reliability. For details refer to the on-line MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Typ | Unit |
|---------------|--|---|----------|------|
| $R_{th(j-c)}$ | thermal resistance from junction to case | $T_{case} = 80\text{ °C}; P_{L(AV)} = 250\text{ W}$ | [1] 0.15 | K/W |

[1] $R_{th(j-c)}$ is measured under RF conditions.

6. Characteristics

Table 6. DC characteristics

$T_j = 25\text{ °C}$; per section unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------|----------------------------------|---|---------|-----|-----|------------------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $V_{GS} = 0\text{ V}; I_D = 2.4\text{ mA}$ | [1] 110 | - | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $V_{DS} = 10\text{ V}; I_D = 240\text{ mA}$ | [1] 1.4 | 1.9 | 2.4 | V |
| I_{DSS} | drain leakage current | $V_{GS} = 0\text{ V}; V_{DS} = 50\text{ V}$ | - | - | 2.8 | μA |
| I_{DSX} | drain cut-off current | $V_{GS} = V_{GS(th)} + 3.75\text{ V}; V_{DS} = 10\text{ V}$ | - | 36 | - | A |
| I_{GSS} | gate leakage current | $V_{GS} = 10\text{ V}; V_{DS} = 0\text{ V}$ | - | - | 280 | nA |
| $R_{DS(on)}$ | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75\text{ V}; I_D = 8.5\text{ A}$ | [1] - | 143 | - | $\text{m}\Omega$ |

[1] I_D is the drain current.

Table 7. AC characteristics

$T_j = 25\text{ °C}$; per section unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|------------------------------|---|-------|-----|-----|------|
| C_{iss} | input capacitance | $V_{GS} = 0\text{ V}; V_{DS} = 50\text{ V}; f = 1\text{ MHz}$ | [1] - | 220 | - | pF |
| C_{oss} | output capacitance | $V_{GS} = 0\text{ V}; V_{DS} = 50\text{ V}; f = 1\text{ MHz}$ | - | 74 | - | pF |
| C_{rss} | reverse transfer capacitance | $V_{GS} = 0\text{ V}; V_{DS} = 50\text{ V}; f = 1\text{ MHz}$ | - | 1.2 | - | pF |

[1] Capacitance values without internal matching.

Table 8. RF characteristics

RF characteristics in Ampleon production narrowband test circuit; $T_{case} = 25\text{ °C}$ unless otherwise specified.

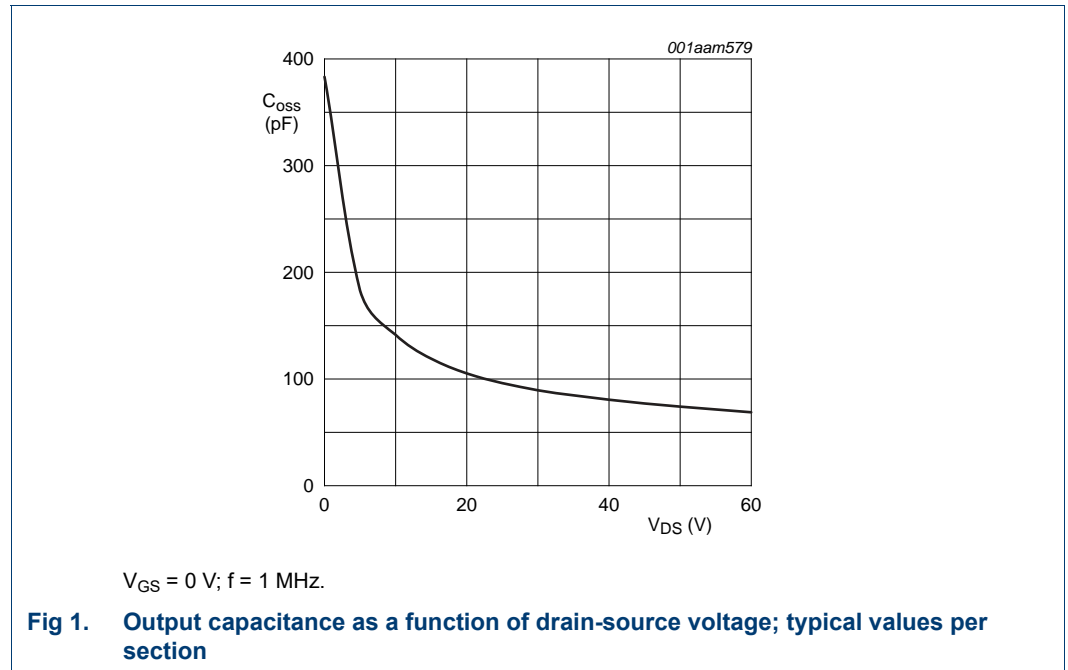
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------|--|--|-------|------|-----|------|
| 2-Tone, class-AB | | | | | | |
| V_{DS} | drain-source voltage | | - | 50 | - | V |
| I_{Dq} | quiescent drain current | | [1] - | 1.3 | - | A |
| $P_{L(AV)}$ | average output power | $f_1 = 860\text{ MHz}; f_2 = 860.1\text{ MHz}$ | 250 | - | - | W |
| G_p | power gain | $f_1 = 860\text{ MHz}; f_2 = 860.1\text{ MHz}$ | 19.8 | 20.8 | - | dB |
| η_D | drain efficiency | $f_1 = 860\text{ MHz}; f_2 = 860.1\text{ MHz}$ | 42 | 46 | - | % |
| IMD3 | third-order intermodulation distortion | $f_1 = 860\text{ MHz}; f_2 = 860.1\text{ MHz}$ | - | -32 | -28 | dBc |

Table 8. RF characteristics ...continued

RF characteristics in Ampleon production narrowband test circuit; $T_{case} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------|-------------------------|----------------------|------|------|-----|---------------|
| Pulsed, class-AB | | | | | | |
| V_{DS} | drain-source voltage | | - | 50 | - | V |
| I_{Dq} | quiescent drain current | | [1] | 1.3 | - | A |
| $P_{L(M)}$ | peak output power | $f = 860\text{ MHz}$ | - | 600 | - | W |
| G_p | power gain | $f = 860\text{ MHz}$ | 17.2 | 19.8 | - | dB |
| η_D | drain efficiency | $f = 860\text{ MHz}$ | 54 | 58 | - | % |
| t_p | pulse duration | | - | 100 | - | μs |
| δ | duty cycle | | - | 20 | - | % |

[1] I_{Dq} for total device



7. Test information

7.1 Ruggedness in class-AB operation

The BLF10H6600P and BLF10H6600PS are capable of withstanding a load mismatch corresponding to $V_{SWR} \geq 40 : 1$ through all phases under the following conditions:

$V_{DS} = 50\text{ V}; I_{Dq} = 1.3\text{ A}; P_L = 600\text{ W}$ (pulsed); $f = 860\text{ MHz}$.

7.2 Impedance information

Table 9. Typical push-pull impedance

Simulated Z_i and Z_L device impedance; impedance info at $V_{DS} = 50$ V and $P_{L(AV)} = 600$ W (pulsed CW). See [Figure 2](#) for definition of transistor impedance.

| f | Z_i | Z_L |
|------|----------------|----------------|
| MHz | Ω | Ω |
| 300 | 0.607 + j0 | 5.495 + j1.936 |
| 325 | 0.622 – j1.441 | 5.324 + j2.008 |
| 350 | 0.639 – j1.121 | 5.151 + j2.065 |
| 375 | 0.658 – j0.826 | 4.977 + j2.107 |
| 400 | 0.679 – j0.551 | 4.805 + j2.136 |
| 425 | 0.703 – j0.291 | 4.634 + j2.153 |
| 450 | 0.73 – j0.044 | 4.466 + j2.157 |
| 475 | 0.76 + j0.194 | 4.301 + j2.151 |
| 500 | 0.793 + j0.424 | 4.14 + j2.134 |
| 525 | 0.83 + j0.648 | 3.984 + j2.109 |
| 550 | 0.872 + j0.869 | 3.833 + j2.075 |
| 575 | 0.919 + j1.088 | 3.687 + j2.033 |
| 600 | 0.972 + j1.305 | 3.546 + j1.985 |
| 625 | 1.032 + j1.523 | 3.411 + j1.931 |
| 650 | 1.101 + j1.741 | 3.281 + j1.871 |
| 675 | 1.179 + j1.963 | 3.156 + j1.807 |
| 700 | 1.268 + j2.187 | 3.036 + j1.738 |
| 725 | 1.371 + j2.416 | 2.922 + j1.666 |
| 750 | 1.49 + j2.651 | 2.813 + j1.591 |
| 775 | 1.629 + j2.891 | 2.708 + j1.512 |
| 800 | 1.792 + j3.138 | 2.609 + j1.432 |
| 825 | 1.984 + j3.39 | 2.514 + j1.349 |
| 850 | 2.212 + j3.649 | 2.423 + j1.264 |
| 875 | 2.484 + j3.91 | 2.336 + j1.178 |
| 900 | 2.812 + j4.17 | 2.254 + j1.091 |
| 925 | 3.209 + j4.421 | 2.175 + j1.003 |
| 950 | 3.689 + j4.648 | 2.1 + j0.913 |
| 975 | 4.27 + j4.829 | 2.029 + j0.823 |
| 1000 | 4.967 + j4.927 | 1.96 + j0.733 |

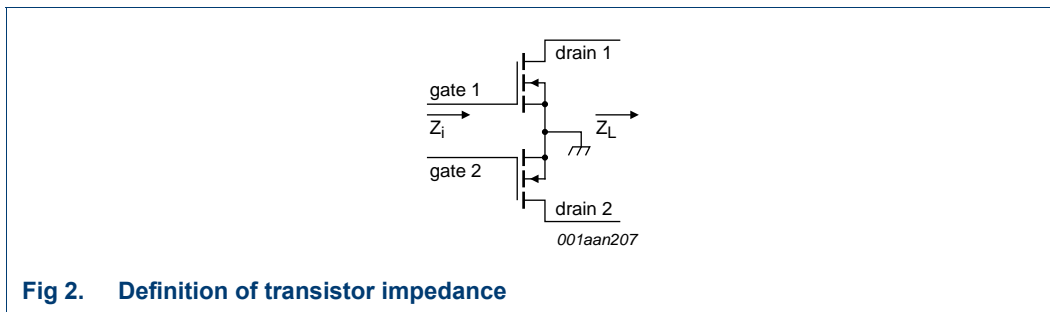


Fig 2. Definition of transistor impedance

7.3 Test circuit information

Table 10. List of components

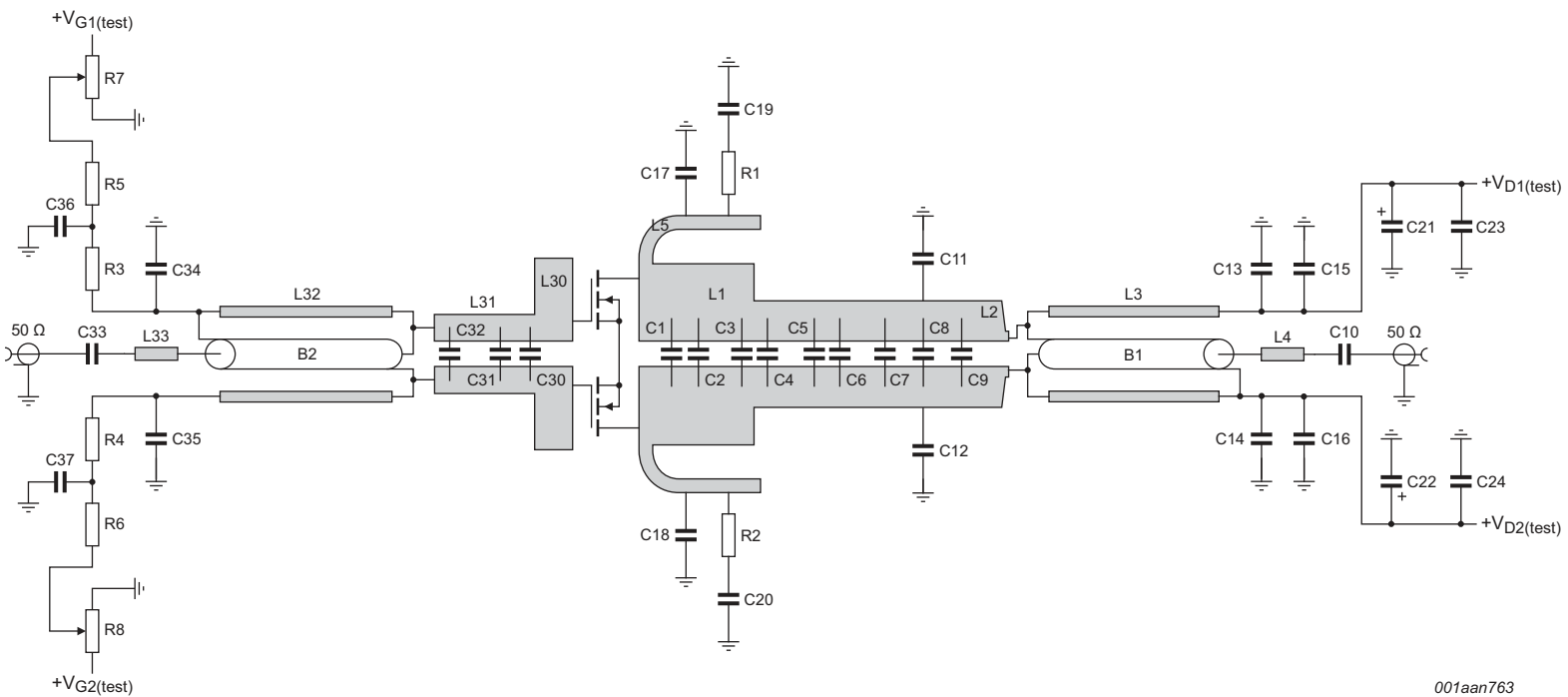
For test circuit, see [Figure 3](#), [Figure 4](#) and [Figure 5](#).

| Component | Description | Value | Remarks |
|--------------------|-----------------------------------|---------------|---|
| B1, B2 | semi rigid coax | 25 Ω; 49.5 mm | UT-090C-25 (EZ 90-25) |
| C1 | multilayer ceramic chip capacitor | 12 pF | [1] |
| C2, C3, C4, C5, C6 | multilayer ceramic chip capacitor | 8.2 pF | [1] |
| C7 | multilayer ceramic chip capacitor | 6.8 pF | [2] |
| C8 | multilayer ceramic chip capacitor | 2.7 pF | [2] |
| C9 | multilayer ceramic chip capacitor | 2.2 pF | [2] |
| C10, C13, C14 | multilayer ceramic chip capacitor | 100 pF | [3] |
| C11, C12 | multilayer ceramic chip capacitor | 10 pF | [2] |
| C15, C16 | multilayer ceramic chip capacitor | 4.7 μF, 50 V | Kemet C1210X475K5RAC-TU or capacitor of same quality. |
| C17, C18, C23, C24 | multilayer ceramic chip capacitor | 100 pF | [2] |
| C19, C20 | multilayer ceramic chip capacitor | 10 μF, 50 V | TDK C570X7R1H106KT000N or capacitor of same quality. |
| C21, C22 | electrolytic capacitor | 470 μF; 63 V | |
| C30 | multilayer ceramic chip capacitor | 10 pF | [4] |
| C31 | multilayer ceramic chip capacitor | 9.1 pF | [4] |
| C32 | multilayer ceramic chip capacitor | 3.9 pF | [4] |
| C33, C34, C35 | multilayer ceramic chip capacitor | 100 pF | [4] |
| C36, C37 | multilayer ceramic chip capacitor | 4.7 μF, 50 V | TDK C4532X7R1E475MT020U or capacitor of same quality. |
| L1 | microstrip | - | [5] (W × L) 15 mm × 13 mm |
| L2 | microstrip | - | [5] (W × L) 5 mm × 26 mm |
| L3, L32 | microstrip | - | [5] (W × L) 2 mm × 49.5 mm |
| L4 | microstrip | - | [5] (W × L) 1.7 mm 3.5 mm |
| L5 | microstrip | - | [5] (W × L) 2 mm × 9.5 mm |
| L30 | microstrip | - | [5] (W × L) 5 mm × 13 mm |
| L31 | microstrip | - | [5] (W × L) 2 mm × 11 mm |
| L33 | microstrip | - | [5] (W × L) 2 mm × 3 mm |
| R1, R2 | wire resistor | 10 Ω | |

Table 10. List of components ...continued
 For test circuit, see [Figure 3](#), [Figure 4](#) and [Figure 5](#).

| Component | Description | Value | Remarks |
|-----------|---------------|-------|---------|
| R3, R4 | SMD resistor | 5.6 Ω | 0805 |
| R5, R6 | wire resistor | 100 Ω | |
| R7, R8 | potentiometer | 10 kΩ | |

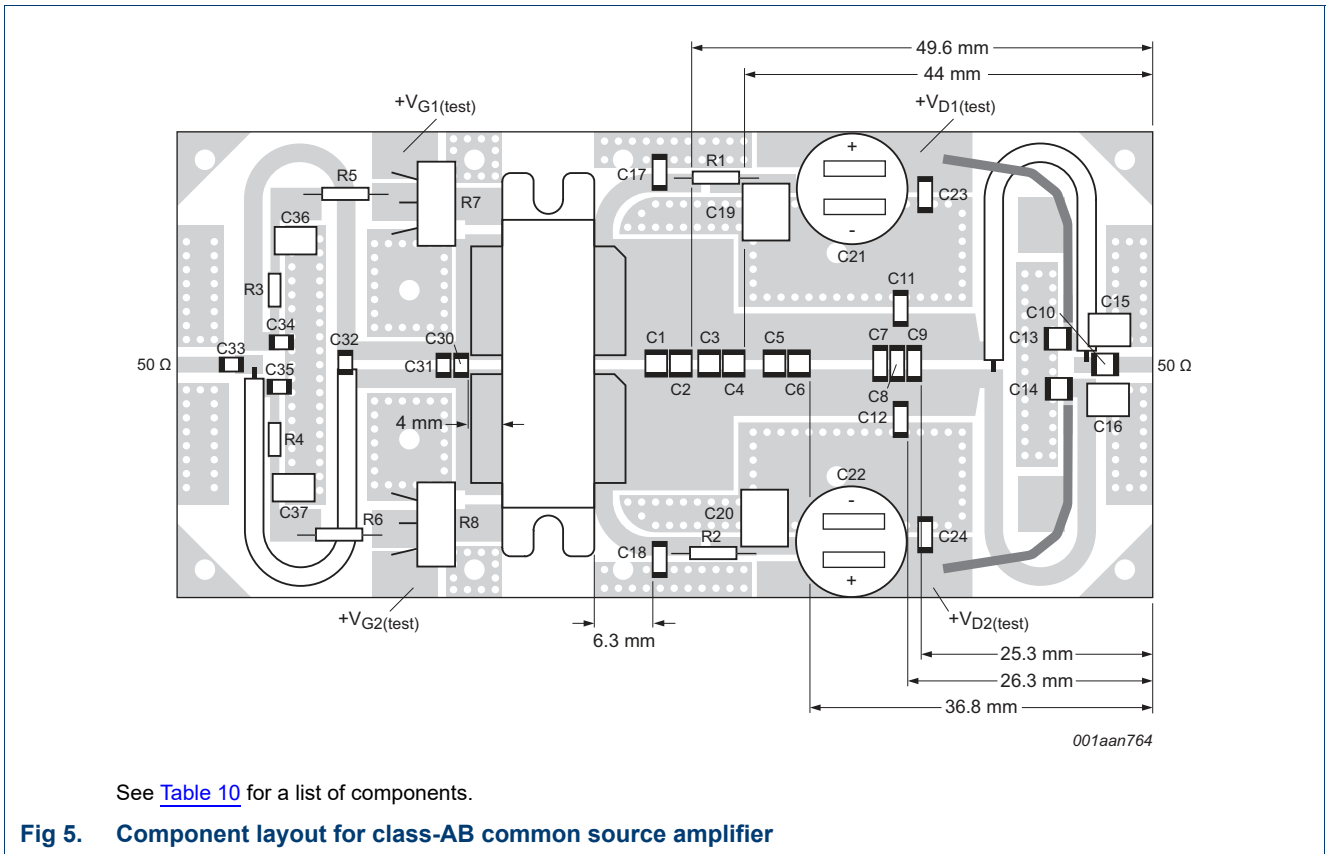
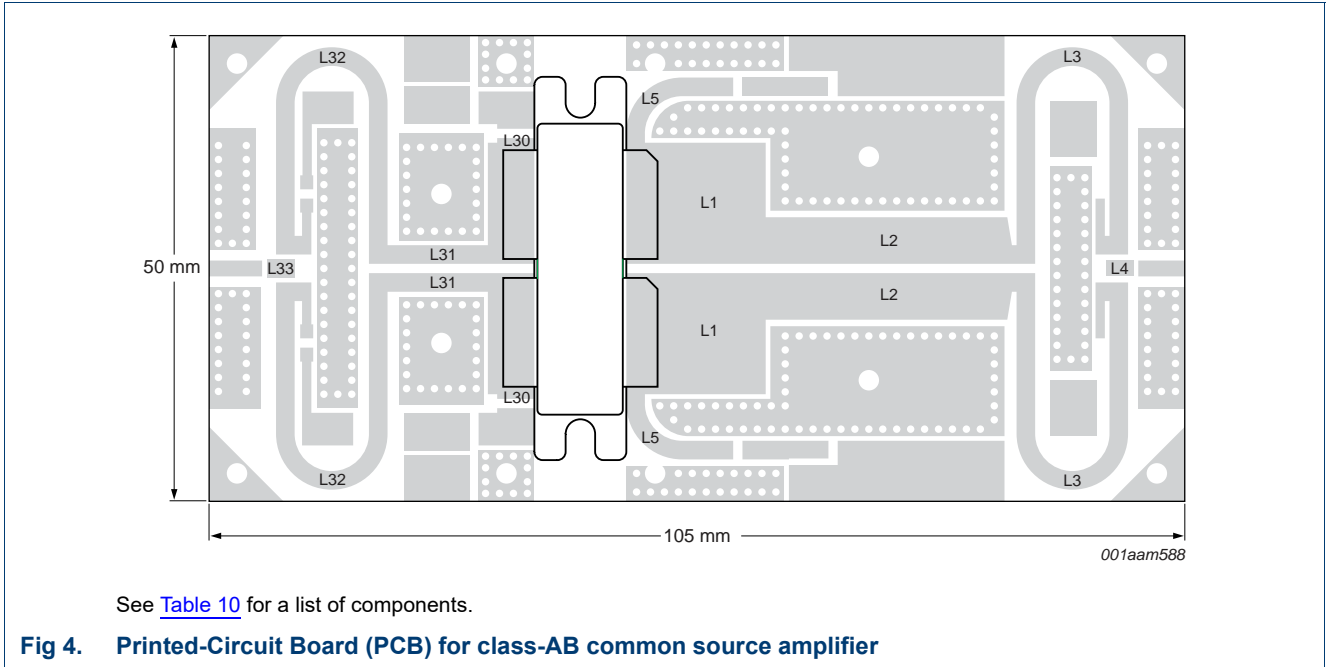
- [1] American technical ceramics type 800R or capacitor of same quality.
- [2] American technical ceramics type 800B or capacitor of same quality.
- [3] American technical ceramics type 180R or capacitor of same quality.
- [4] American technical ceramics type 100A or capacitor of same quality.
- [5] Printed-Circuit Board (PCB): Taconic RF35; $\epsilon_r = 3.5$ F/m; height = 0.762 mm; Cu (top/bottom metallization); thickness copper plating = 35 μm.



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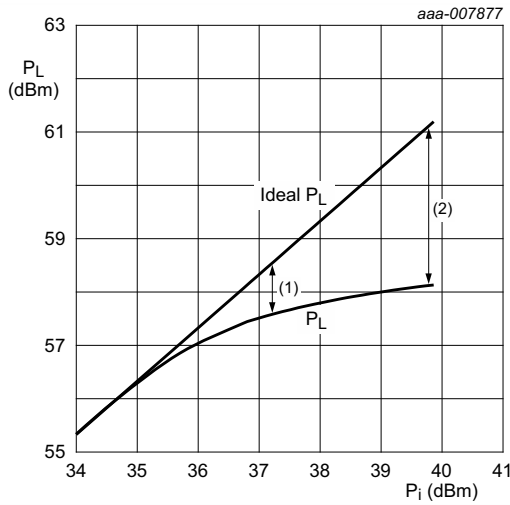
See [Table 10](#) for a list of components.

Fig 3. Class-AB common source broadband amplifier; $V_{D1(test)}$, $V_{D2(test)}$, $V_{G1(test)}$ and $V_{G2(test)}$ are drain and gate test voltages



7.4 Graphical data

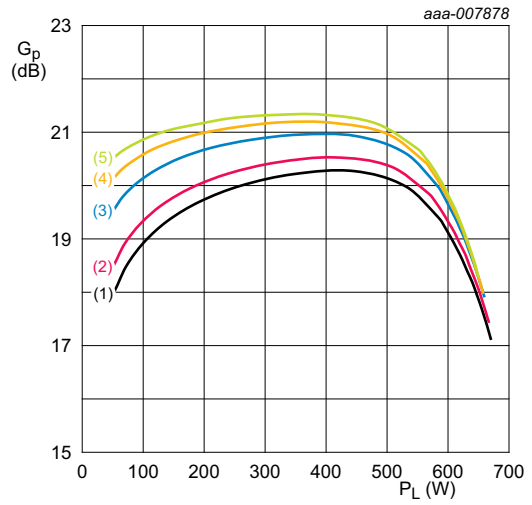
7.4.1 Pulsed



$V_{DS} = 50 \text{ V}$; $I_{Dq} = 1300 \text{ mA}$; $f = 860 \text{ MHz}$; $t_p = 100 \mu\text{s}$; $\delta = 20 \%$.

(1) $P_{L(1dB)} = 57.6 \text{ dBm}$ (575 W)
 (2) $P_{L(3dB)} = 58.1 \text{ dBm}$ (649 W)

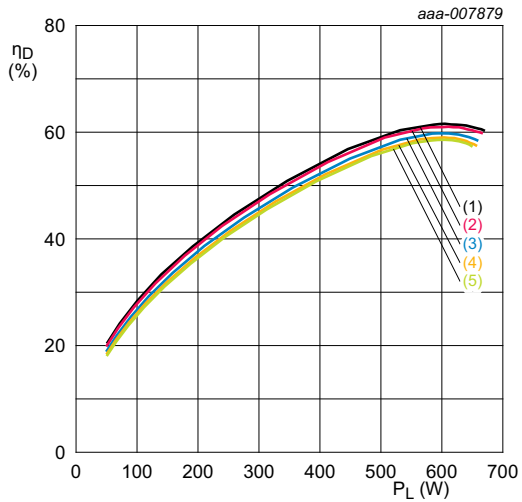
Fig 6. Output power as a function of input power; typical values



$V_{DS} = 50 \text{ V}$; $f = 860 \text{ MHz}$; $t_p = 100 \mu\text{s}$; $\delta = 20 \%$.

(1) $I_{Dq} = 100 \text{ mA}$
 (2) $I_{Dq} = 200 \text{ mA}$
 (3) $I_{Dq} = 600 \text{ mA}$
 (4) $I_{Dq} = 1000 \text{ mA}$
 (5) $I_{Dq} = 1300 \text{ mA}$

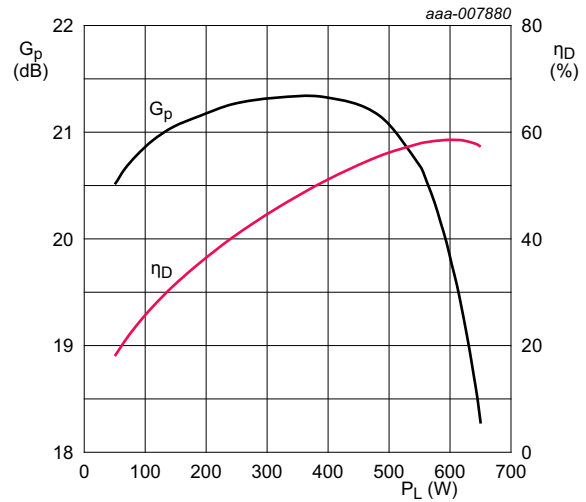
Fig 7. Power gain as a function of output power; typical values



$V_{DS} = 50\text{ V}$; $f = 860\text{ MHz}$; $t_p = 100\ \mu\text{s}$; $\delta = 20\ \%$.

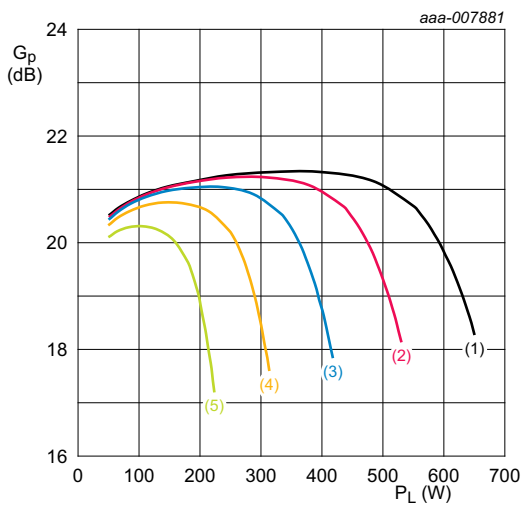
- (1) $I_{Dq} = 100\text{ mA}$
- (2) $I_{Dq} = 200\text{ mA}$
- (3) $I_{Dq} = 600\text{ mA}$
- (4) $I_{Dq} = 1000\text{ mA}$
- (5) $I_{Dq} = 1300\text{ mA}$

Fig 8. Drain efficiency as a function of output power; typical values



$V_{DS} = 50\text{ V}$; $I_{Dq} = 1300\text{ mA}$; $f = 860\text{ MHz}$; $t_p = 100\ \mu\text{s}$; $\delta = 20\ \%$.

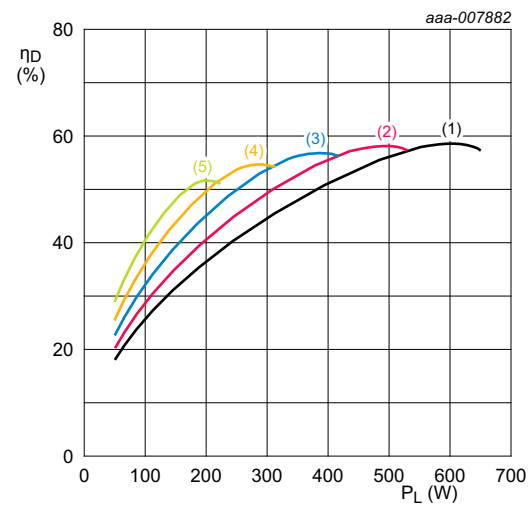
Fig 9. Power gain and drain efficiency as function of output power; typical values



$I_{Dq} = 1300\text{ mA}$; $f = 860\text{ MHz}$; $t_p = 100\ \mu\text{s}$; $\delta = 20\ \%$.

- (1) $V_{DS} = 50\text{ V}$
- (2) $V_{DS} = 45\text{ V}$
- (3) $V_{DS} = 40\text{ V}$
- (4) $V_{DS} = 35\text{ V}$
- (5) $V_{DS} = 30\text{ V}$

Fig 10. Power gain as a function of output power; typical values

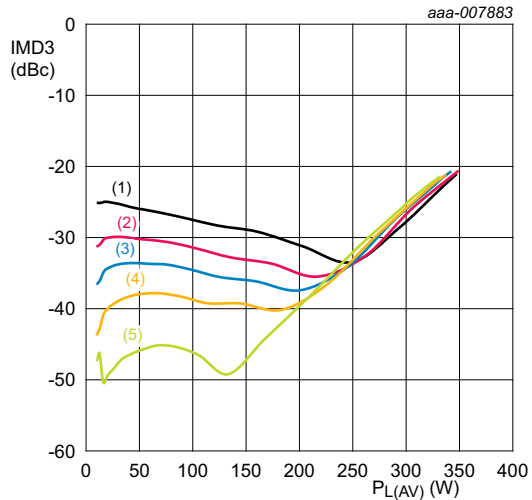


$I_{Dq} = 1300\text{ mA}$; $f = 860\text{ MHz}$; $t_p = 100\ \mu\text{s}$; $\delta = 20\ \%$.

- (1) $V_{DS} = 50\text{ V}$
- (2) $V_{DS} = 45\text{ V}$
- (3) $V_{DS} = 40\text{ V}$
- (4) $V_{DS} = 35\text{ V}$
- (5) $V_{DS} = 30\text{ V}$

Fig 11. Drain efficiency as a function of output power; typical values

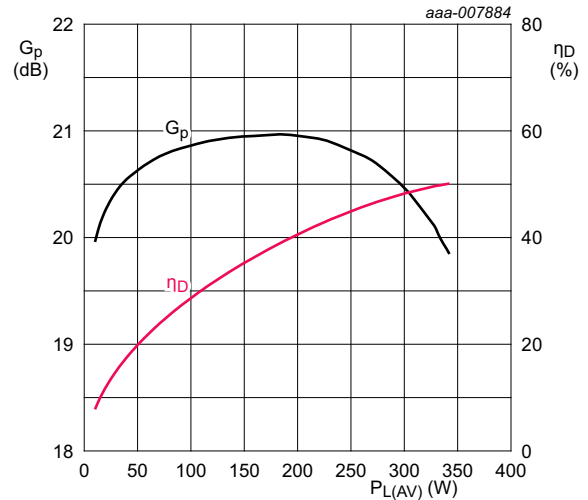
7.4.2 2-Tone CW



$V_{DS} = 50 \text{ V}; f_1 = 860.0 \text{ MHz}; f_2 = 860.1 \text{ MHz}.$

- (1) $I_{Dq} = 600 \text{ mA}$
- (2) $I_{Dq} = 1000 \text{ mA}$
- (3) $I_{Dq} = 1300 \text{ mA}$
- (4) $I_{Dq} = 1600 \text{ mA}$
- (5) $I_{Dq} = 2000 \text{ mA}$

Fig 12. Third-order intermodulation distortion as a function of average output power; typical values



$V_{DS} = 50 \text{ V}; I_{Dq} = 1300 \text{ mA}; f_1 = 860.0 \text{ MHz}; f_2 = 860.1 \text{ MHz}.$

Fig 13. Power gain and drain efficiency as function of average output power; typical values

8. Package outline

Flanged balanced ceramic package; 2 mounting holes; 4 leads

SOT539A

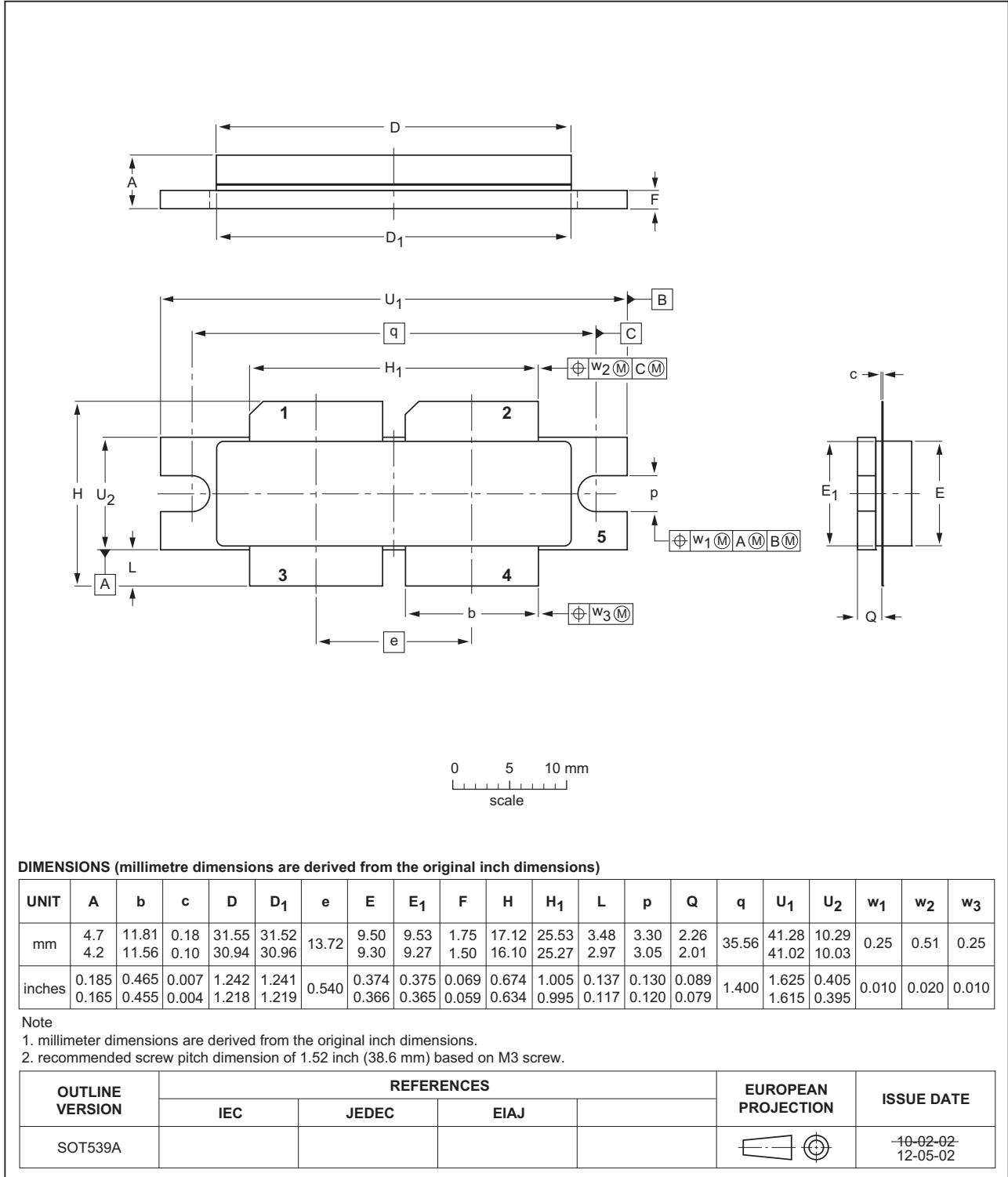


Fig 14. Package outline SOT539A

Earless flanged balanced ceramic package; 4 leads

SOT539B

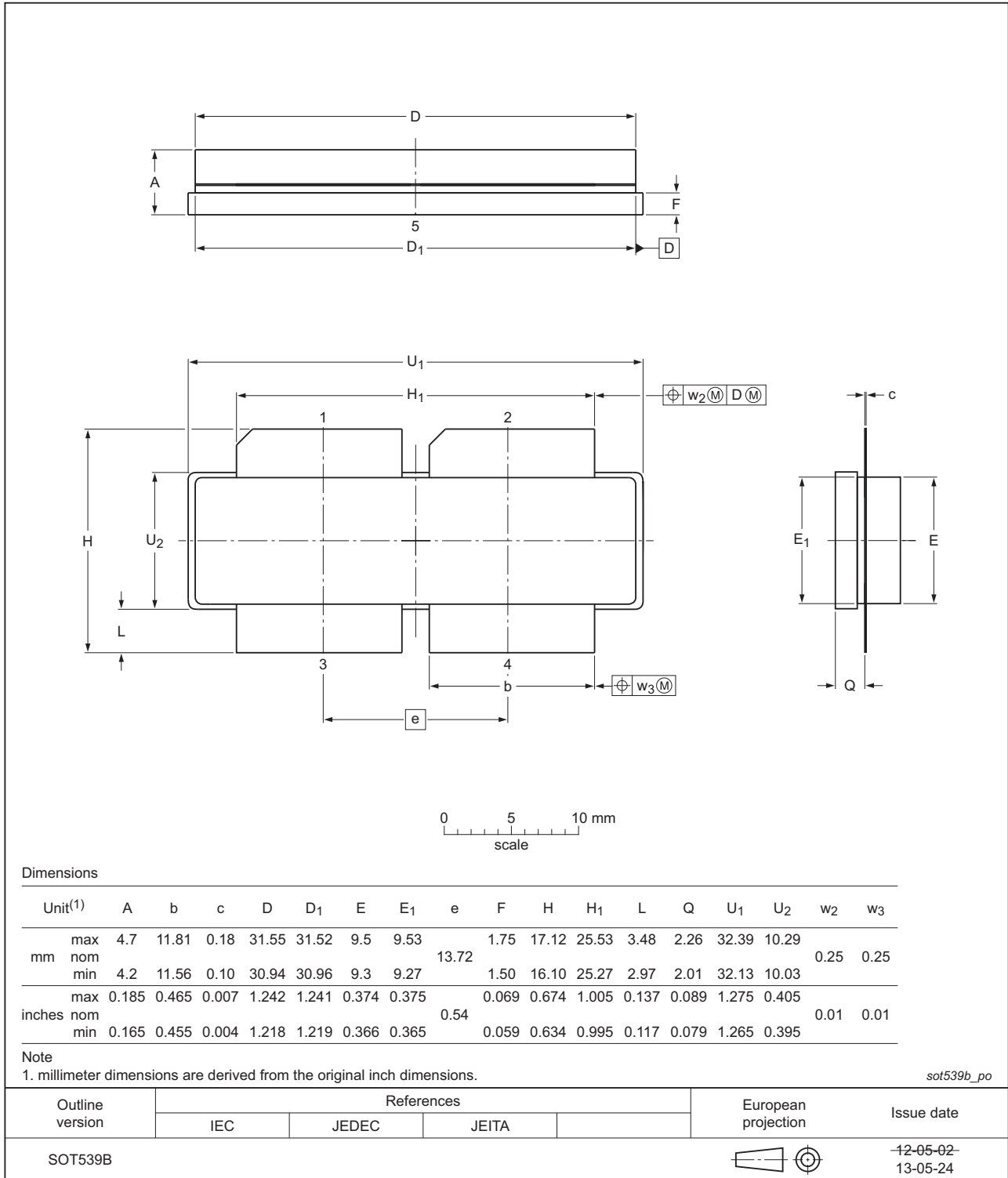


Fig 15. Package outline SOT539B

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

10. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|--|
| CCDF | Complementary Cumulative Distribution Function |
| CW | Continuous Wave |
| LDMOS | Laterally Diffused Metal-Oxide Semiconductor |
| SMD | Surface Mounted Device |
| VSWR | Voltage Standing-Wave Ratio |

11. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------------------|--|----------------------|---------------|------------------------------|
| BLF10H6600P_BLF10H6600PS#3 | 20150901 | Product data sheet | - | BLF10H6600P_BLF10H6600PS v.2 |
| Modifications: | <ul style="list-style-type: none"> The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. | | | |
| BLF10H6600P_BLF10H6600PS v.2 | 20130620 | Product data sheet | - | BLF0510H6600P v.1 |
| BLF0510H6600P v.1 | 20121009 | Objective data sheet | - | - |

12. Legal information

12.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.ampleon.com>.

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